

Features

- Trench Power LV MOSFET Technology
- Moisture Sensitivity Level 1
- Halogen Free. "Green" Device (Note 1)
- Epoxy Meets UL 94 V-0 Flammability Rating
- Lead Free Finish/RoHS Compliant ("P" Suffix Designates RoHS Compliant. See Ordering Information)

Maximum Ratings

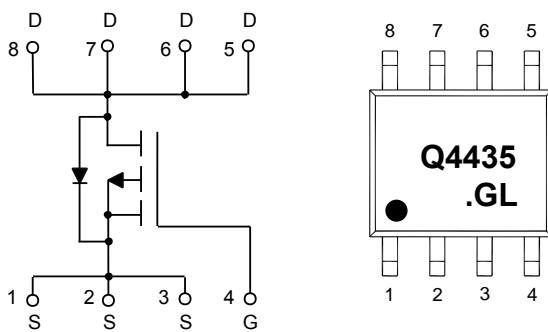
- Operating Junction Temperature Range: -55°C to +150°C
- Storage Temperature Range: -55°C to +150°C
- Thermal Resistance: 89°C/W Junction to Ambient^(Note2)

| Parameter | Symbol | Rating | Unit |
|--|-----------------|--------|------|
| Drain-Source Voltage | V _{DS} | -30 | V |
| Gate-Source Voltage | V _{GS} | ±20 | V |
| Continuous Drain Current T _A =25°C | I _D | -9.1 | A |
| T _A =70°C | | -7.2 | |
| Pulsed Drain Current ^(Note 3) | I _{DM} | -36 | A |
| Total Power Dissipation ^(Note 4) | P _D | 1.4 | W |
| Single Pulsed Avalanche Energy ^(Note 5) | E _{AS} | 20 | mJ |

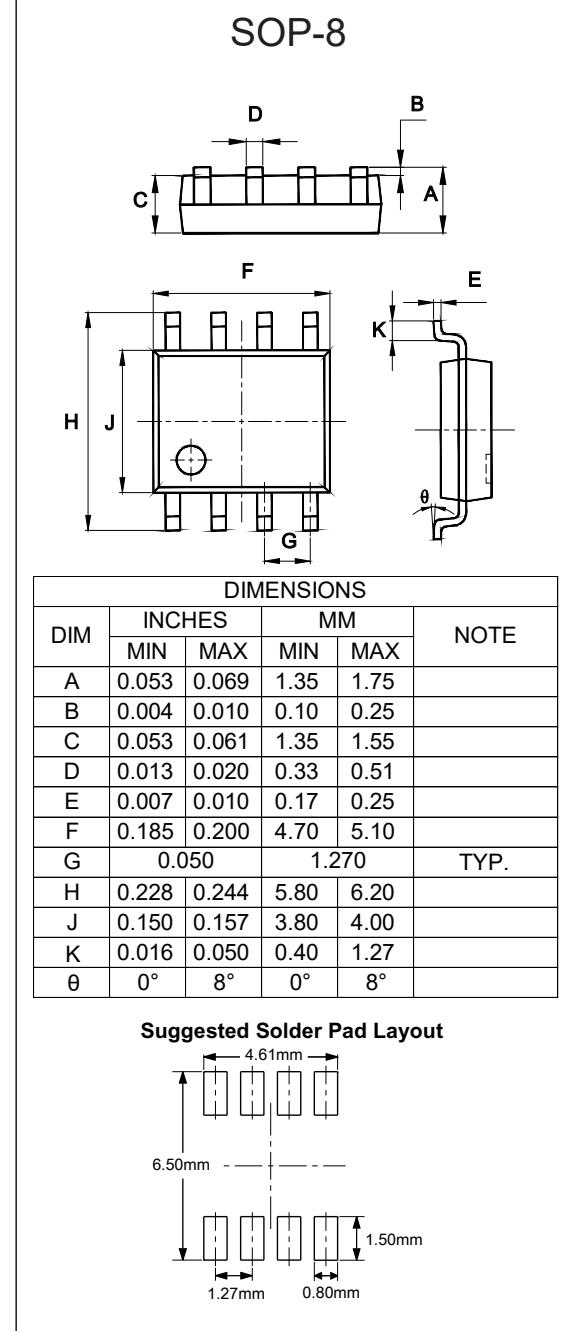
Note:

1. Halogen free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
2. The value of R_{θJA} is measured with the device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with T_A=25°C.
3. Repetitive rating; pulse width limited by max. junction temperature.
4. P_D is based on max. junction temperature, using junction-ambient thermal resistance.
5. T_J=25°C, V_{DD}=-30V, V_{GS}=-10V, R_G=25Ω, L=0.5mH.

Internal Structure and Marking Code



P-Channel Power MOSFET



ELECTRICAL CHARACTERISTICS (Ta=25°C unless otherwise specified)

| Parameter | Symbol | Test Conditions | Min | Typ | Max | Unit |
|---------------------------------|----------------------|---|------|------|------|------|
| Static Characteristics | | | | | | |
| Drain-Source Breakdown Voltage | V _{(BR)DSS} | V _{GS} =0V, I _D =-250μA | -30 | | | V |
| Gate-Source Leakage Current | I _{GSS} | V _{DS} =0V, V _{GS} =±20V | | | ±100 | nA |
| Zero Gate Voltage Drain Current | I _{DSS} | V _{DS} =-30V, V _{GS} =0V | | | -1 | μA |
| Gate-Threshold Voltage | V _{GS(th)} | V _{DS} =V _{GS} , I _D =-250μA | -1.0 | -1.5 | -3 | V |
| Drain-Source On-Resistance | R _{DS(on)} | V _{GS} =-10V, I _D =-9.1A | | 14 | 24 | mΩ |
| | | V _{GS} =-4.5V, I _D =-6.9A | | 19 | 35 | |
| Gate Resistance | R _G | f=1MHz, Open drain | | 5 | | Ω |
| Diode Characteristics | | | | | | |
| Continuous Body Diode Current | I _S | | | | -9.1 | A |
| Diode Forward Voltage | V _{SD} | V _{GS} =0V, I _S =-2A | | | -1.2 | V |
| Reverse Recovery Time | t _{rr} | I _F =5A, dI _F /dt=-100A/μs | | 22 | | ns |
| Reverse Recovery Charge | Q _{rr} | | | 9.6 | | nC |
| Dynamic Characteristics | | | | | | |
| Input Capacitance | C _{iss} | V _{DS} =-15V, V _{GS} =0V, f=1MHz | | 1812 | | pF |
| Output Capacitance | C _{oss} | | | 238 | | |
| Reverse Transfer Capacitance | C _{rss} | | | 193 | | |
| Total Gate Charge | Q _g | V _{DS} =-15V, V _{GS} =-10V, I _D =-9.1A | | 33 | | nC |
| Gate-Source Charge | Q _{gs} | | | 4 | | |
| Gate-Drain Charge | Q _{gd} | | | 6 | | |
| Turn-On Delay Time | t _{d(on)} | V _{DD} =-15V, V _{GS} =-10V, R _G =2.5Ω, I _D =-5A | | 7.5 | | ns |
| Turn-On Rise Time | t _r | | | 3.6 | | |
| Turn-Off Delay Time | t _{d(off)} | | | 48 | | |
| Turn-Off Fall Time | t _f | | | 20 | | |

Curve Characteristics

Fig.1 - Typical Output Characteristics

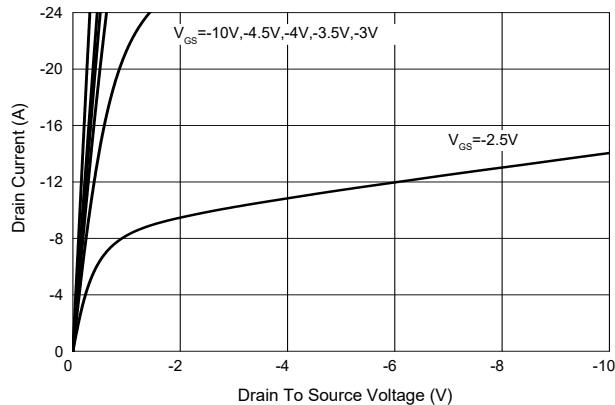


Fig.2 - Transfer Characteristic

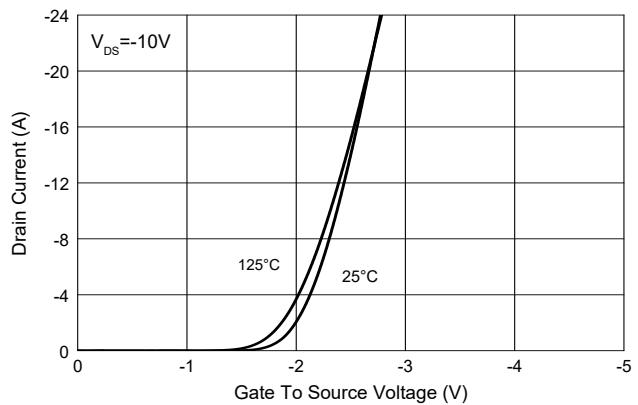


Fig.3 - $R_{DS(ON)}$ - V_{GS}

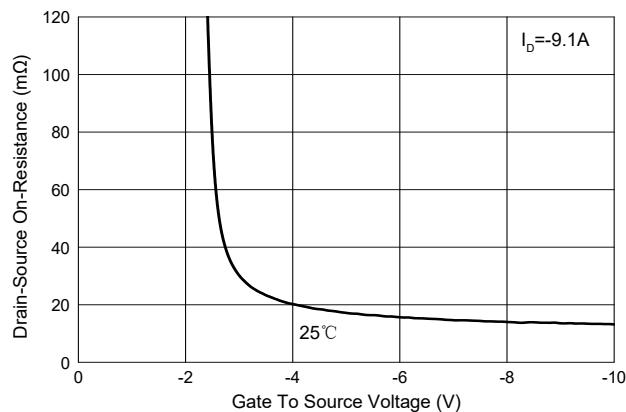


Fig.4 - $R_{DS(ON)}$ - I_D

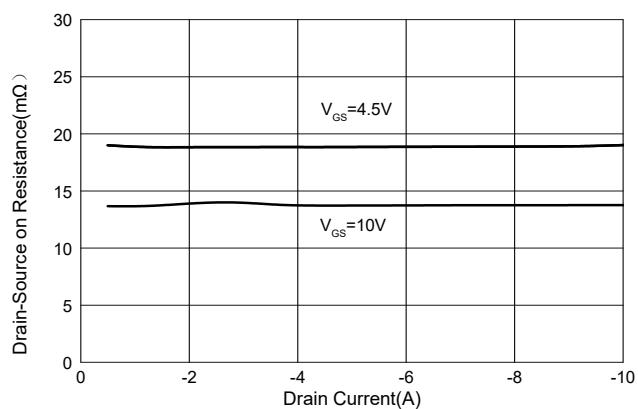


Fig.5 - Capacitance Characteristics

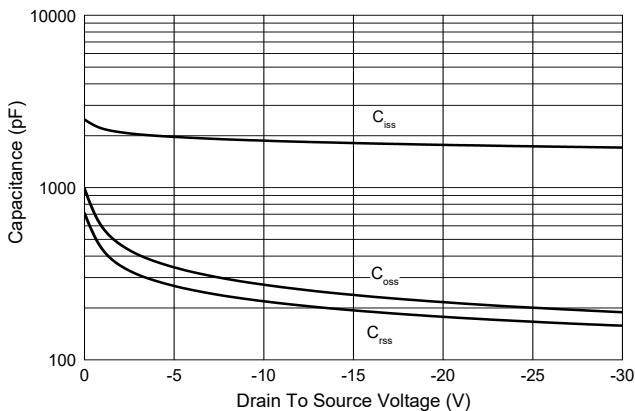
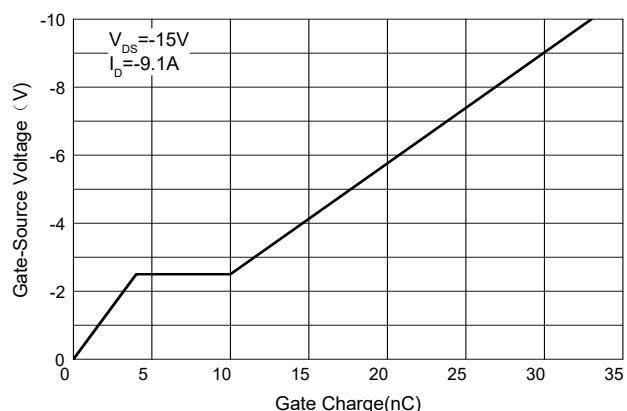


Fig.6 - Gate Charge



Curve Characteristics

Fig.7 - Normalized Threshold Voltage

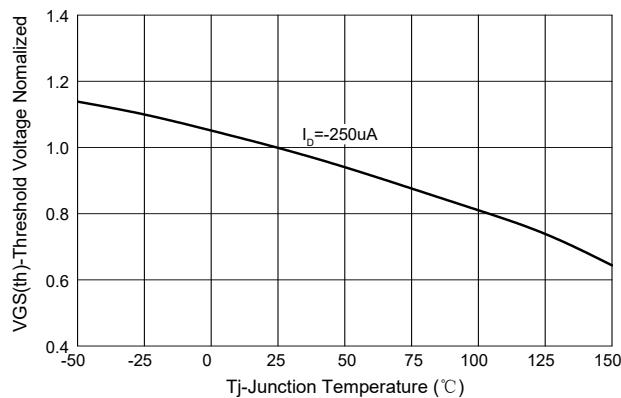


Fig.8 - Normalized On Resistance Characteristics

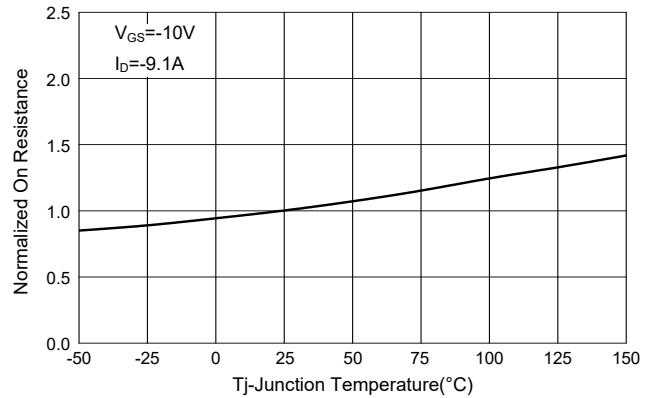


Fig.9 - I_S - V_{SD}

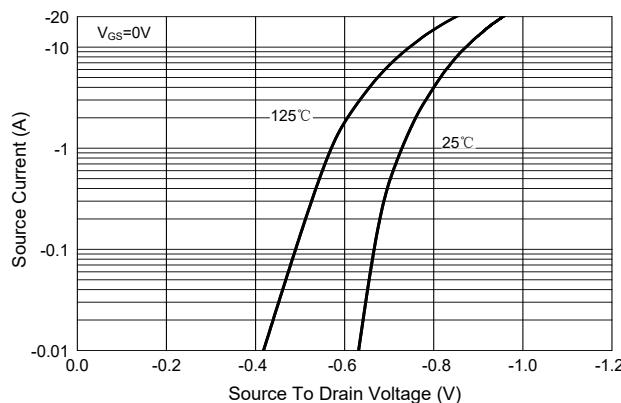


Fig.10 - Drain Current

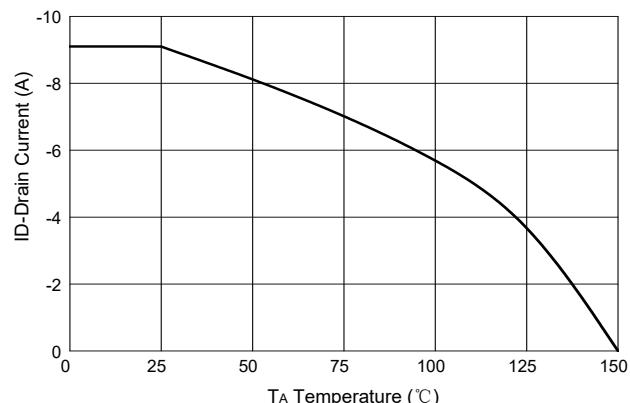
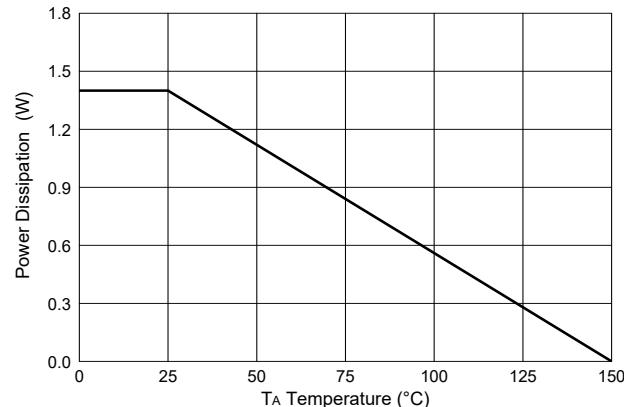
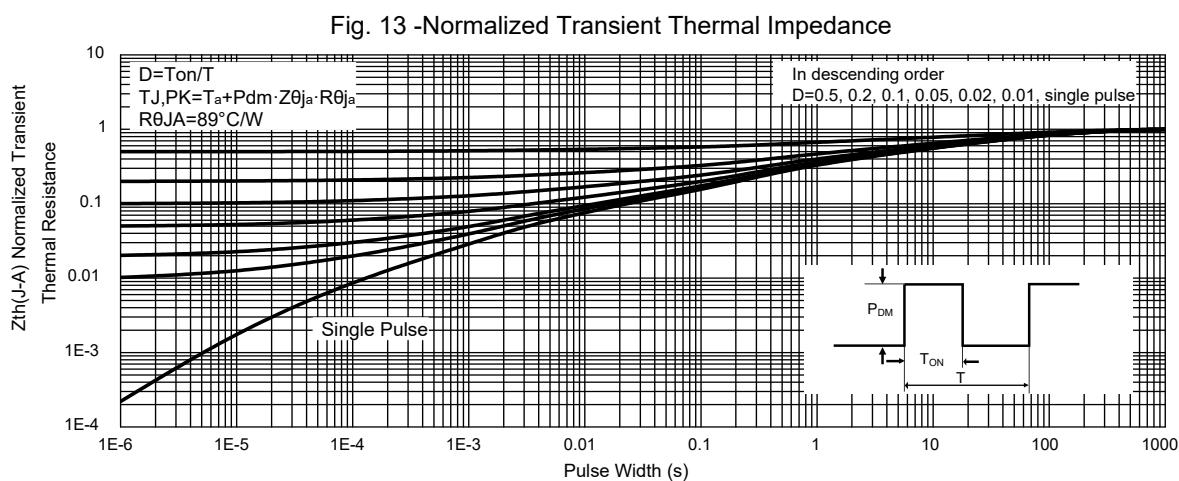
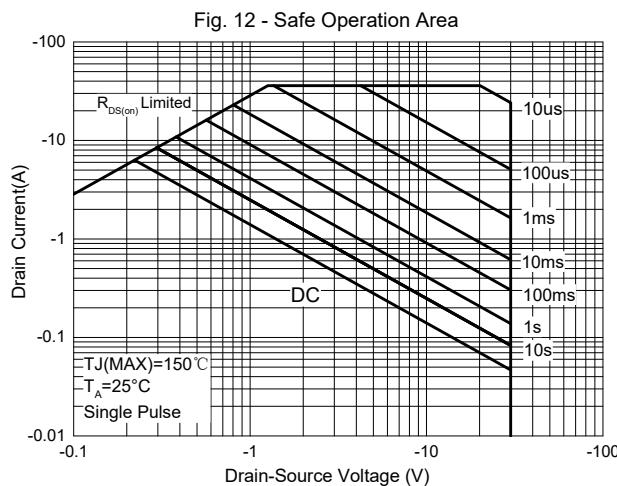


Fig.11 - PD Dissipation



Curve Characteristics



Ordering Information

| Device | Packing |
|----------------|----------------------|
| Part Number-TP | Tape&Reel:4Kpcs/Reel |

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